

	SPEC	CIFICATIONS	
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	Approval For Specifications Or	ily. 38 of	
	* This specification is subject to	o change without notice.	
	Please contact Powertin or it	's representative before designing you	
		to representative before designing you	product based on this specification.
	Approval For Specifications an	d Sample.	
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Note : For detailed information please refer to IC data sheet :

Primacy(TFT LCD) :Himax: HX8218-A + HX8615A (Or comparable IC)



1. SPECIFICATIONS

1.1 Features

LCM

Item	Standard Value
Display Type	320(R、G、B) * 240 Dots
LCD Type	Normally white, Transmissive type
Screen size(inch)	3.5 inch
Viewing Direction	6 O'clock
Color configuration	RGB-Strip
Backlight Type	LED
Interface	Digital 24-bits RGB
Driver IC	HX8218-A + HX8615A
	(Or comparable IC)
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web side :
	http://www.powertip.com.tw/news/LatestNews.asp

LCM Weight : 40 g



1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	76.9(W) * 63.9 (L) * 4.85 (H)(Max)	mm

LCM

Item	Standard Value	Unit
Active Area	70.08 (W) * 52.56 (L)	mm
Dot Pitch	0.219 (W) * 0.219 (L)	mm

Note : For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
	VDD	AVSS=0	-0.3	7.0	
	VCC	GND=0	-0.3	7.0	
System Power Supply Voltage	VGH	GND=0	-0.3	32.0	V
	VGL	GND=0	-22.0	0.3	
	VGH-VGL	GND=0	-0.3	45.0	
Input Voltago	Vi	-	-0.3	VDD+0.3	V
Input Voltage	VI	-	-0.3	VCC+0.3	V
Operating Temperature	T _{OP}	Excluded B/L&T/P	-20	70	°C
Storage Temperature	T _{ST}	Excluded B/L&T/P	-30	80	°C



1.4 DC Electrical Characteristics

Module				Gnd =	0V , Ta = 2	25°C
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Digital Supply Voltage	VCC	-	3	3.3	3.6	V
Digital Operation Current	ICC	-	-	1.8	2.7	mA
Analog Supply Voltage	VDD	-	3.8	5	5.5	V
Analog Operation Current	IDD	-	-	5.8	8.7	mA
Frame frequency	fFrame	-	-	60	90	Hz
Dot Data Clock	DCLK	-	-	-	6.4	MHz

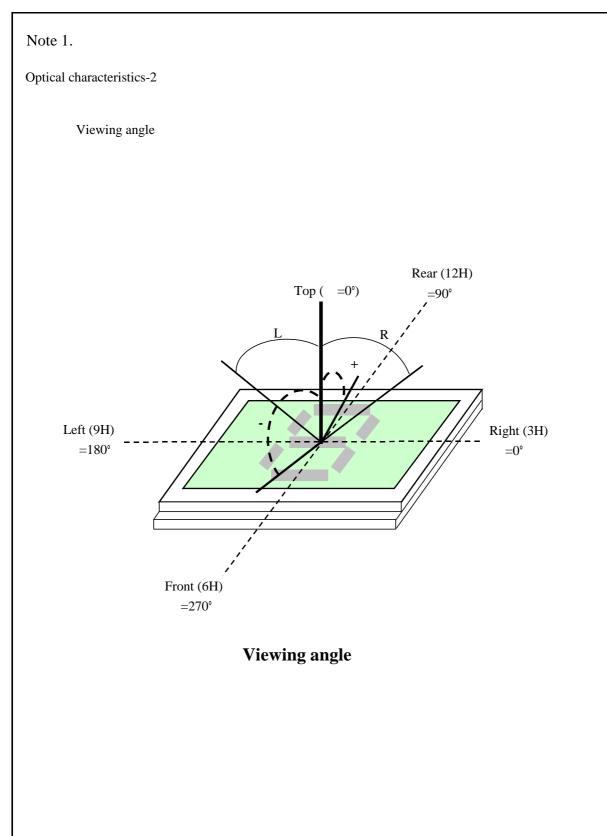


1.5 Optical Characteristics TFT LCD panel

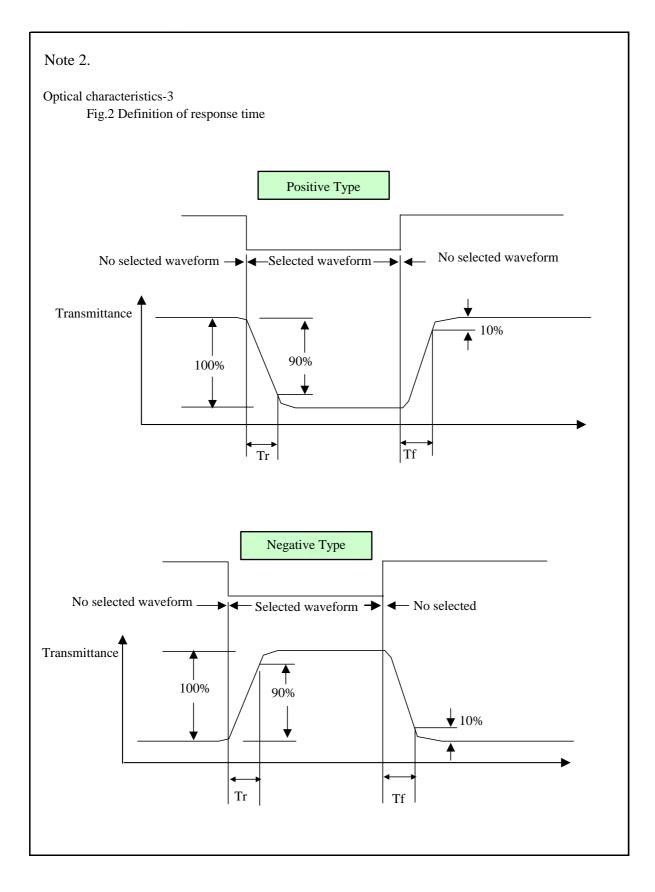
Item		Symbol	Condition	Min.	Тур.	Max.	unit	
	Rise	Tr		-	15	30		
Response time	Fall	Tf		-	35	50	ms	Note2
	White	Х		0.264	0.314	0.364		
	VIIILE	Y	Ta = 25°C	0.310	0.360	0.410		
	Red	Х	$\theta X, \theta Y = 0^{\circ}$	0.546	0.596	0.646		
Color of CIE	Reu	Y	0, 01 = 0	0.295	0.345	0.395		
Coordinate*1	Green	Х		0.267	0.317	0.361	_	-
	Green	Y		0.522	0.572	0.622		
	Blue	Х		0.086	0.136	0.186		
		Y		0.127	0.177	0.227		
	Тор	θY+	CR ≥ 10	-	45	-	deg.	Note1
) (i an sin an an al a	Bottom	θY-		-	50	-		
Viewing angle	Left	θx-		-	50	-		
	Right	θx+		-	50	-		
Contrast ration	0	CR	Ta = 25°C	150	200	-	-	Note3
Average Brightr	ness							
Pattern=white display		IV	IF= 20mA	180	200	-	cd/m ²	
(With LCD)	(With LCD)							
Uniformity (With LCD)*1		В	IF= 20mA	70	-	-	%	

*1 : B=B(min) / B(max)

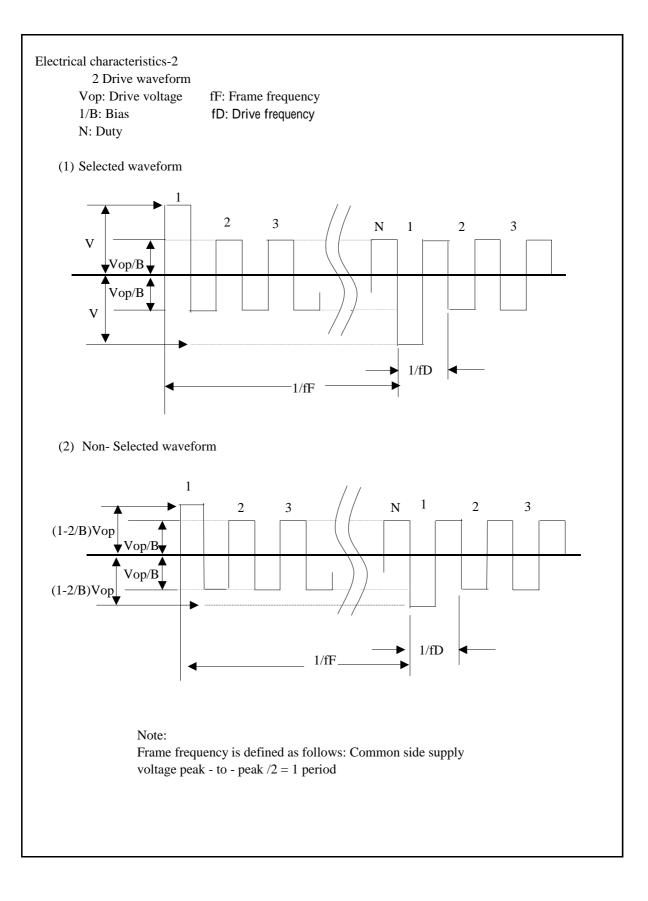




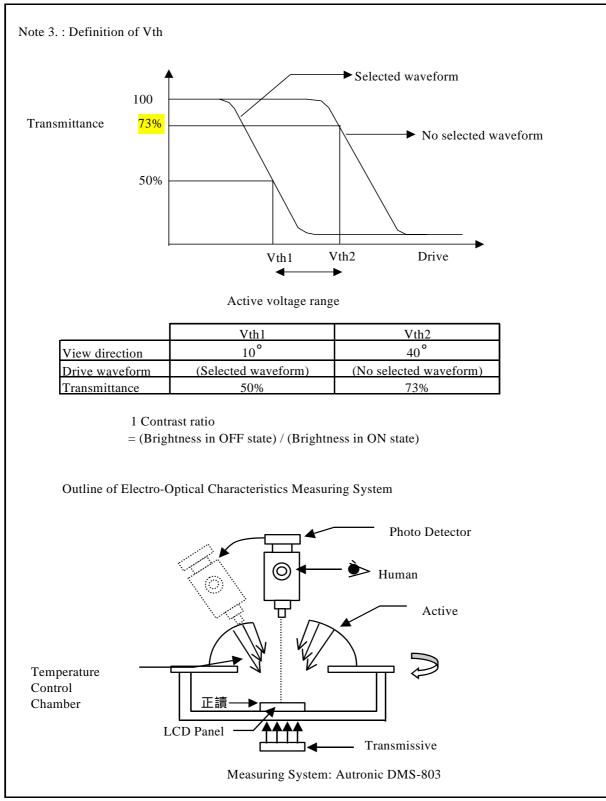














1.6 Backlight Characteristics

LCD Module with LED Backlight

Maximum Ratings

Item	Symbol	Conditions	Min.	Тур	Max.	Unit
Forward Current	I _F	Ta =25°C	-	20	-	mA
Forward Voltage	V _F	Ta =25°C	-	19.8	21.0	V
Power Dissipation	PD	Ta =25°C	-	-	420	mW



1.7 Touch Screen Characteristic

Operating Voltage

DC 5.0V or less.

Terminal Resistance

X direction 200~900 ,Y direction 200~900

Linearity

1.5% or less

Insulation Resistance

20M or more at DC25V

Chatting

10ms or less at ON/OFF(Test Conditions)

Tip silicon rubber R0.8mm hardness 60°, loading 250g. Measure by TD210 digital real-time oscilloscope.

Operation Force

Touch force 60g (with R8.0mm silicon finger)

Impact Resistance

No damage when 9mm steel ball is dropped on the surface from 30cm height

Static Load Resistance

After 45N load is applied on the area (25 cm^2) of the touch panel after 30sec., still satisfy requirements in section 4 and 5-1.

Surface Hardness

3H or higher (with JIS K5600-5-4 standard)

Tail Peeling Resistance

0.5 kg/cm peeling upward by 90 degree

Tail Bending Resistance

Bending 10 times or more by bending radius R1.0mm 500g, each left and right side 135 degree

Tail Insert/Pull Out Resistance

20 times at least (for HSC/FPC connector)

Light Transmittance

Transmittance 80% or more (total transmittance)(by BYK Gardner Hazegard Plus)

Haze

7 or more for anti-glare type (by BYK Gardner Hazegard Plus)



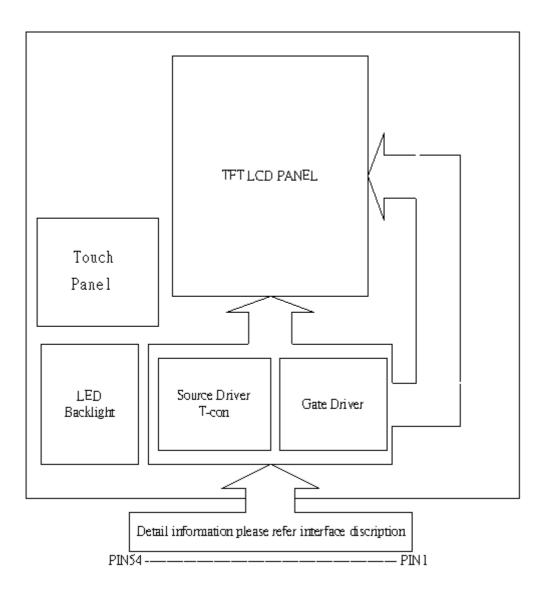
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

Pin No.	Symbol	Function
1	VBL-	Power supply for LED Backlight cathode input
2	VBL-	Power supply for LED Backlight cathode input
3	VBL+	Power supply for LED Backlight anode input
4	VBL+	Power supply for LED Backlight anode input
5	NC	Not used , Must be open
6	/RESET	Hardware reset
7	POL	Connect to Vcom circuit
8	Y1	Touch panel TOP
9	X1	Touch panel RIGHT
10	Y2	Touch panel BOTTOM
11	X2	Touch panel LEFT
12	B0	Blue data bit 0
13	B1	Blue data bit 1
14	B2	Blue data bit 2
15	B3	Blue data bit 3
16	B4	Blue data bit 4
17	B5	Blue data bit 5
18	B6	Blue data bit 6
19	B7	Blue data bit 7
20	G0	Green data bit 0
21	G1	Green data bit 1
22	G2	Green data bit 2
23	G3	Green data bit 3
24	G4	Green data bit 4
25	G5	Green data bit 5
26	G6	Green data bit 6
27	G7	Green data bit 7
28	R0	Red data bit 0
29	R1	Red data bit 1
30	R2	Red data bit 2
31	R3	Red data bit 3

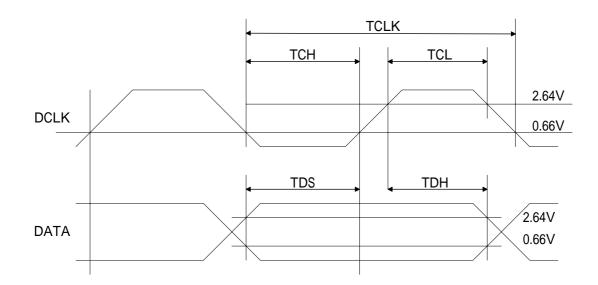
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32	R4	Red data bit 4			
33	R5	Red data bit 5			
34	R6	Red data bit 6			
35	R7	Red data bit 7			
36	HSYNC	Horizontal sync input			
37	VSYNC	Vertical sync input			
38	DCLK	Dot data clock			
39	Vdd	Analog power			
40	Vdd	Analog power			
41	Vcc	Digital power			
42	Vcc	Digital power			
43	SPENA	Serial port data enable signal			
44	NC	Not used , Must be open			
45	Vgl	Gate off power			
46	NC	Not used , Must be open			
47	Vgн	Gate on power			
48	NC	Not used , Must be open			
49	SPCLK	Serial data clock			
50	SPDAT	Serial data			
51	VCOM	VCOM power			
52	ENB	Data enable control			
53	GND	Ground			
54	VSS	Ground			

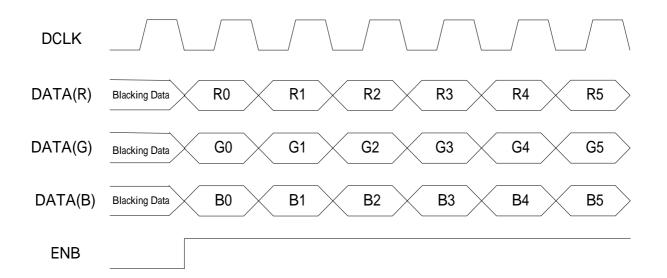


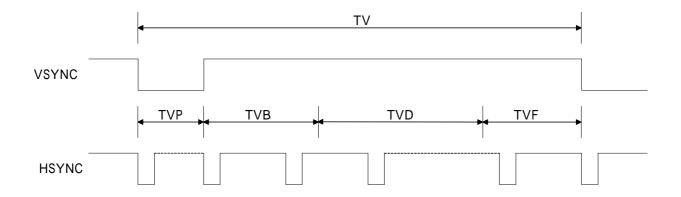
2.3 Timing Characteristics

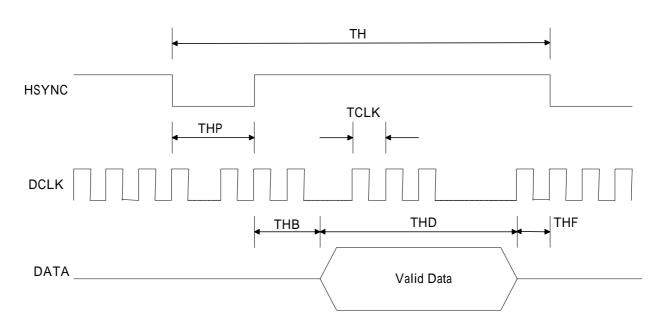
Signal	Iten	Symbol	Min.	Тур.	Max.	Unit	
	Frequency		Dclk	-	6.4	-	MHz
Dclk	High T	High Time		-	78	-	ns
	Low T	Low Time		-	78	-	ns
Data	Setup Time		Tds	12		-	ns
Dala	Hold T	Hold Time		12		-	ns
	Period		TH	-	408	-	DCLK
	Pulse Width		Thp	-	30	-	DCLK
Hsync	Back-Porch		Thb	-	38	-	DCLK
	Display Period		Thd	-	320	-	DCLK
	Front-Porch		Thf	-	20	-	DCLK
	Period	NTSC		-	262.5		TH
		PAL			312.5		
	Pulse Width		Тvр	1	3	5	TH
Vsync	Back-Porch	NTSC	Tvb	-	15		TH
vsync		PAL			23		111
	Display Period		Tvd	-	240	-	TH
	Front-Porch	NTSC	Tvf	-	4.5		тц
		PAL			46.5		TH



POWERTIP



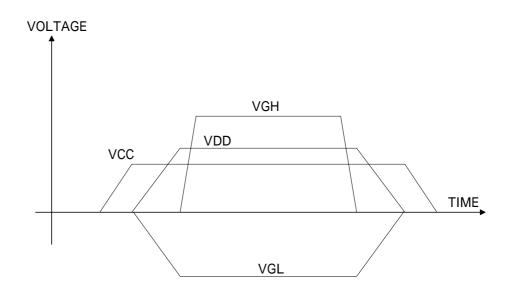






2.4 Power Sequence

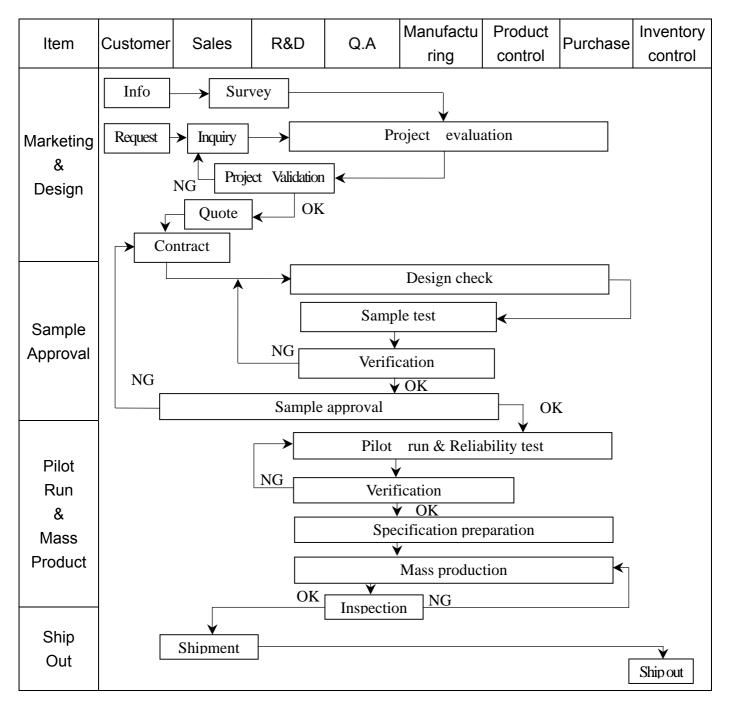
The LCD panel adopts high voltage driver ICs, so it could be permanently damaged if a wrong power on/off sequence is used, When powering on the LCD, VCC should go up firstly, and then turn on VGL and VDD, and finally VGH, Turn off the LCD panel with reversed order or shut off all the power supplies simultaneously.



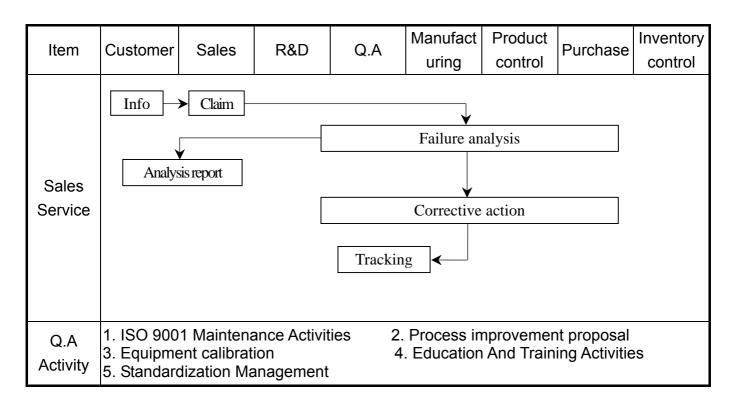


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart





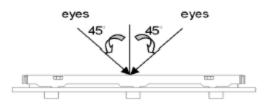




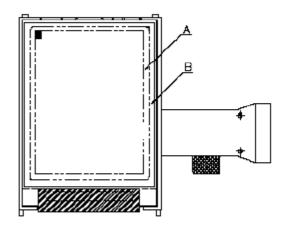
3.2 Inspection Specification

1. Inspection Specification

- ◆Scope : The document shall be applied to TFT-LCD Module for 3. 5" ~10" (Ver. 02).
- ◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- Equipment : Gauge \ MIL-STD \ Powertip Tester \ Sample
- ◆Defect Level : Major Defect AQL : 0.4 ; Minor Defect AQL : 1.5
- ♦OUT Going Defect Level : Sampling.
- Standard of the product appearance test :
 - a. Manner of appearance test :
 - (1). The test best be under 20W×2 fluorescent light , and distance of view must be at 30 cm.
 - (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

B area : Outside of viewing area

(4). Standard of inspection : (Unit : mm)

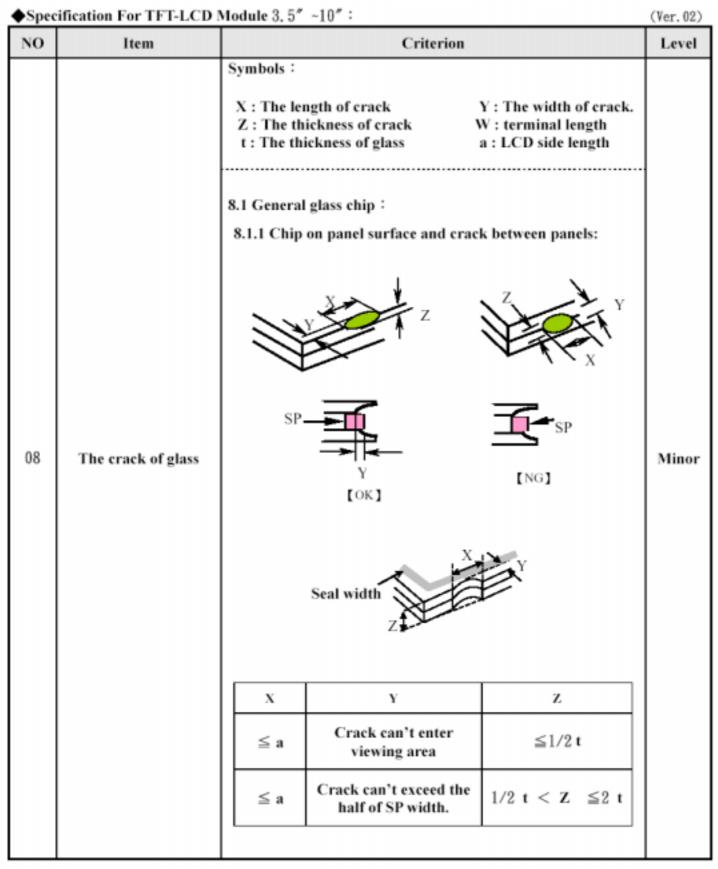


NO		◆Specification For TFT-LCD Module 3, 5″~10″ : (Ver.						
	Item	Criterion			Level			
		1. 1The part number is inconsistent with work order of production.						
01	01 Product condition		1.2 Mixed product types.					
		1. 3 Asse	mbled i	n inverse direction.		Major		
02	Quantity	2. 1The c	quantity	is inconsistent with	n work order of production.	Major		
03	Outline dimension		3.1 Product dimension and structure must conform to structure diagram.			^e Major		
04 EI	Electrical Testing	4.1 Missing line character and icon.						
		4, 2 No function or no display.						
		4. 3 Display malfunction.						
		4. 4 LCD viewing angle defect.						
		4. 5 Current consumption exceeds product specifications.						
	Dot defect (Bright dot >			Item	Acceptance (Q'ty)			
		[Bright Dot	≦ 4			
			Dot	Dark Dot	≦ 5			
05			Defect	Joint Dot	≦ 3			
	Dark dot)			Total	≦ 7	Minor		
	On -display	5.1 Inspection pattern : full white , full black , Red , Green and blue screens.				1		
		5. 2 It is defined as dot defect if defect area $>1/2$ dot.						
	5. 3 The distance between two dot defect ≥ 5 mm.							



◆Specification For TFT-LCD Module 3, 5″~10″: (Ver. 0.								
NO	Item	Criterion						
06	Black or white dot \cdot scratch \cdot contamination Round type x $\Phi = (x+y)/2$ Line type L W	0.25 <	$\Phi \leq 0.25$ $\Phi \leq 0.50$ $\Phi > 0.50$ Total on-display or d Width W $0.03 < W$ $0.05 < W$) According to the second sec	eptance (Q'ty) Ignore 5 0 5 Acceptance (Q'ty) Ignore 4 2 As round type 5	Minor		
07	Polarizer Bubble	0.25 < 0	$\begin{array}{l} \textbf{Dimension} (\textbf{diameter}: \Phi) \\ \Phi &\leq 0.25 \\ 0.25 < \Phi &\leq 0.50 \\ 0.50 < \Phi &\leq 0.80 \\ \Phi &> 0.80 \\ \end{array}$ $\begin{array}{l} \textbf{Total} \end{array}$		Acceptance (Q'ty) Ignore 4 1 0 5			







NO	Item	Criterion			Leve	
		Symbols : X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length 8.1.2 Corner crack : X = Z Y = The width of crack. W : terminal length a : LCD side length				
		X	Y		z	
		≦1/5 a	Crack can't e viewing are		$\leq 1/2 t$	
		$\leq 1/5 \text{ a} \begin{array}{c} \text{Crack can't exceed the} \\ \text{half of SP width.} \end{array} 1/2 \ t \ < \ Z \leq 2 \ t \end{array}$			$< Z \leq 2 t$	
08	The crack of glass					
	8.2 Protrusion over terminal : 8.2.1 Chip on electrode pad :					
			Z X	X	Y Z	
			X	Y	Z	
		Front	≦a	$\leq 1/2 W$	≦ t	



◆Specification For TFT-LCD Module 3. 5" ~10": (Ver. 02) NO Level Item Criterion Symbols : X : The length of crack Y: The width of crack. Z : The thickness of crack W: terminal length t : The thickness of glass a : LCD side length 8.2.2 Non-conductive portion : х Y Z The crack of 08 Minor $\leq 1/3$ a $\leq W$ ≤t glass ○ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 8.2.3 Glass remain : Pitch х Y Z $\leq 1/3 W$ ≦ a ≦t



Specify NO	fication For TFT-I	LCD Module 3. 5" ~10" : Criterion	(Ver. 02) Level
110	Backlight elements	9. 1 Backlight can't work normally.	
09		9. 2 Backlight doesn't light or color is wrong.	
		9. 3 Illumination source flickers when lit.	Major
10	General appearance	10. 1 Pin type < quantity < dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC .	
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Мајог
		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	
		10, 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1, 5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

Ver.02

4.1	Reliability Test Condition Ver.02					
NO.	TEST ITEM	TEST CONDITION				
1	High Temperature Storage Test	Keep in +80 ±2 96 hrs Surrounding temperature, then storage at normal condition 4hrs.				
2	Low Temperature Storage Test	Keep in -30 ±2 96 hrs Surrounding temperature, then storage at normal condition 4hrs.				
3	High Temperature / High Humidity Storage Test	Keep in +60 / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)				
		Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-	Contact Discharge: Apply 250 V with 5 times discharge for each polarity +/-			
4	ESD Test	 Temperature ambinace : 15 35 Humidity relative : 30% 60% Energy Storage Capacitance(Cs+Cd) : 150pF±10% Discharge Resistance(Rd) : 330 ±10% Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%) 				
5	Temperature Cycling Storage Test	-20 +25 +70 +25 (30mins) (5mins) (30mins) (5mins) ↓ 10 Cycle ↓ Surrounding temperature, then storage at normal condition 4hrs.				
6	Vibration Test (Packaged)	 Sine wave 10 55 Hz frequency (1 min) The amplitude of vibration :1.5 mm Each direction (X, Y, Z) duration for 2 Hrs 				
7	Drop Test (Packaged)	Packing Weight (Kg) 0 ~ 45.4 45.4 ~ 90.8 90.8 ~ 454	Drop Height (cm) 122 76 61			
		Over 454 Drop direction : 1 corner / 3 edg	46			

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $280 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}C \pm 5^{\circ}C$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

